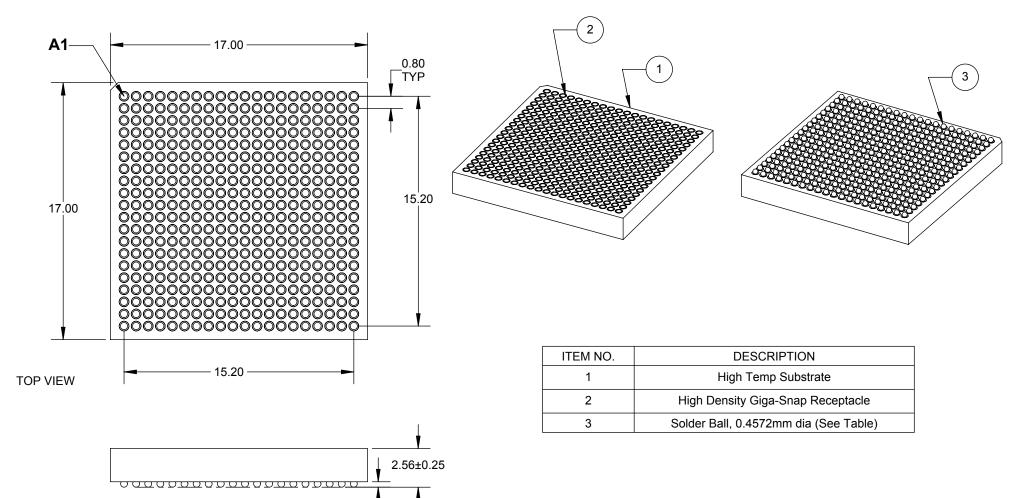
U.S. Patent No. 8,091,222 B2



Description: Giga-snaP BGA SMT Fo	ot.

SIDE VIEW

Primary dimension units are millimeters, Secondary dimension units are [inches].

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

0.36

	SF-BGA400H-B-64 Drawing				
	SF-BGA400H-B-64F Drawing	Material: N/A Finish: N/A Weight: N/A	STATUS: Released	SHEET: 1 OF 2	REV. B
	Ironwood Electronics, Inc. Tele: (800) 404-0204		DRAWN BY: M. Raske	SCALE: 4:1	
	www.ironwoodelectronics.com	Weight. WA	FILE: SF-BGA400H-B-64	DATE: 04/06/2012	

PART NO.

SUFFIX

-64

-64F*

SOLDER BALL ALLOY

Sn63Pb37

Sn96.5Ag3.0Cu0.5

*RoHS Compliant

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Rev	Date	Initials	Description
A - Original		Original	
B 7/7/15 MT/OA updated materials to generic definitions		updated materials to generic definitions	

Description: Revision History

Primary dimension units are millimeters, Secondary dimension units are [inches].

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	Specification	Material: Finish: Weight:	STATUS: Released	SHEET: 2 OF 2	REV. B
	Ironwood Electronics, Inc. Tele: (800) 404-0204		DRAWN BY: M. Raske	SCALE: 1:1	
	www.ironwoodelectronics.com		FILE: SF-BGA400H-B-64	DATE: 04/06/2012	